

Title (en)  
SENSOR MOUNTING SYSTEM

Title (de)  
SENSOR-MONTAGESYSTEM

Title (fr)  
SYSTEME DE MONTAGE DE CAPTEUR

Publication  
**EP 1346331 A2 20030924 (EN)**

Application  
**EP 01992252 A 20011220**

Priority  
• US 0149724 W 20011220  
• US 25708100 P 20001220

Abstract (en)  
[origin: WO0250553A2] An obstacle detection system for vehicular environments including a monitoring sensor system and a mounting system is disclosed. An installer can make aiming adjustments, in the factory or field, to account for tolerance stack-up. The system includes a housing for mounting the monitoring sensor system to minimize cross-talk and interference between transmitter and receiver sections, to limit sensor system movement, and to enable gross and fine aiming adjustments. In one embodiment, a circuit board is disposed within a cradle assembly which, in turn, is mounted in or integral to the housing to position the obstacle detection sensor as necessary. The cradle in one embodiment is an enclosure for the circuit board. The sensor housing is mounted to the interior vehicle trim, door panel, and/or door sheet metal and ensures consistent mounting regardless of interior trim or factory installation variations. Integral adjustment mechanisms are incorporated for adjusting the orientation of the sensor system. The circuit board may be comprised of plural subsections interconnected by flexible circuit board, enabling accurate alignment of each subsection with respect to the environment to be monitored.

IPC 1-7  
**G08B 21/00**; G08B 23/00; G08G 1/16; B60Q 1/00; H02P 3/00; E05F 15/00; G01S 13/00; H01J 40/14; G01C 5/00; G06F 7/00; G08B 13/19

IPC 8 full level  
**B60J 1/00** (2006.01); **B60R 11/02** (2006.01); **G01P 13/00** (2006.01); **G01S 7/481** (2006.01); **G01S 17/04** (2020.01); **G01S 17/88** (2006.01); **B60R 11/00** (2006.01); **G01S 7/497** (2006.01)

CPC (source: EP US)  
**B60R 11/02** (2013.01 - EP US); **G01P 13/00** (2013.01 - EP US); **G01S 7/4813** (2013.01 - EP US); **G01S 17/04** (2020.01 - EP US); **G01S 17/88** (2013.01 - EP US); **B60R 2011/0021** (2013.01 - EP US); **G01S 7/4972** (2013.01 - EP US)

Designated contracting state (EPC)  
AT BE CH CY DE DK ES FI FR GB GR IE IT LI LU MC NL PT SE TR

DOCDB simple family (publication)  
**WO 0250553 A2 20020627**; **WO 0250553 A3 20020912**; **WO 0250553 A8 20030306**; **WO 0250553 A9 20030814**; CA 2432307 A1 20020627; EP 1346331 A2 20030924; EP 1346331 A4 20040714; JP 2005528290 A 20050922; MX PA03005480 A 20030925; US 2002101694 A1 20020801; US 6720884 B2 20040413

DOCDB simple family (application)  
**US 0149724 W 20011220**; CA 2432307 A 20011220; EP 01992252 A 20011220; JP 2004567198 A 20011220; MX PA03005480 A 20011220; US 2906201 A 20011220